

Fig. 1

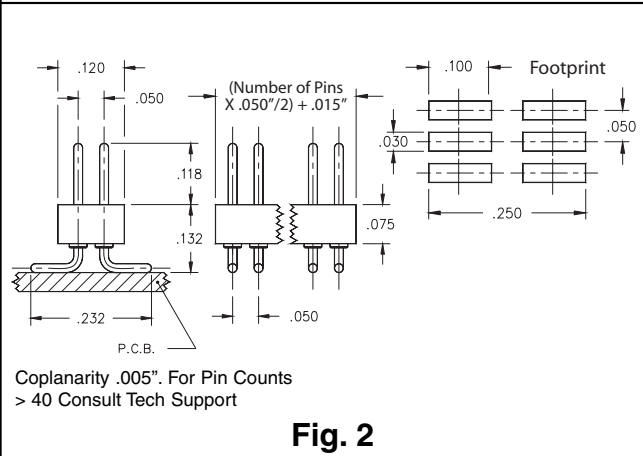


Fig. 2

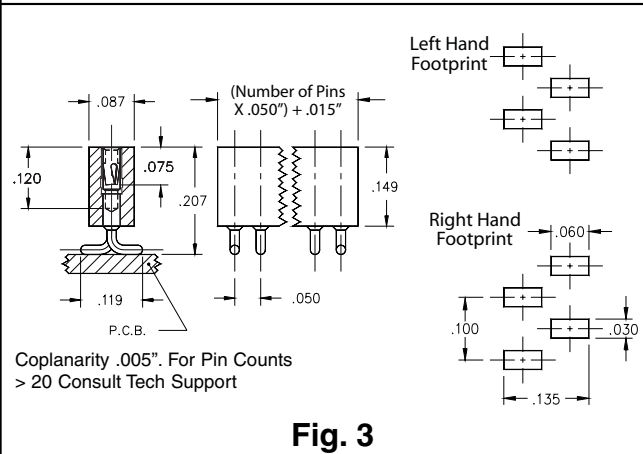


Fig. 3

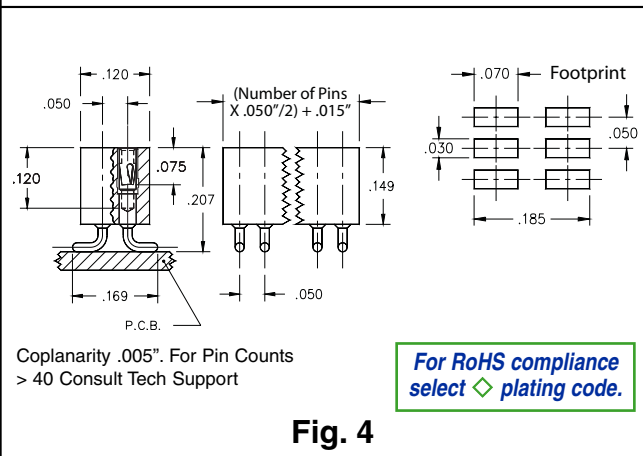
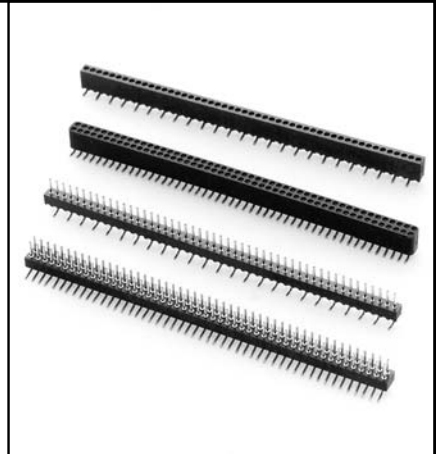


Fig. 4

For RoHS compliance
 select \diamond plating code.

- Single row interconnects having an even number of pins are now available with a left or right hand footprint.
- Headers (850 & 852) use MM# 4006 pins. See page 166 for details.
- Sockets (851 & 853) use MM# 4890-0 receptacles and accept pin diameters from .015-.021. See page 129 for details.
- Coplanarity .005" (Single Row max 20 pins; Double Row max 40 pins) for higher pin counts contact tech support .
- Insulators are high temp. thermoplastic.



Ordering Information

Fig. 1L	Single Row Header, Left Hand Footprint Odd or Even # of pins			
	850-XX-0__-30-001000 Specify # of pins \rightarrow 01-50			
Fig. 1R	Single Row Header, Right Hand Footprint Even # of pins			
	850-XX-0__-30-002000 Specify even # of pins \rightarrow 02-50			
Fig. 2	Double Row Header, Even # of pins			
	852-XX-__-30-001000 Specify even # of pins \rightarrow 004-100			
SPECIFY PLATING CODE XX=		10 \diamond	90	40 \diamond
Pin Plating		10 μ " Au	200 μ " Sn/Pb	200 μ " Sn
Fig. 3L	Single Row Socket, Left Hand Footprint Odd or Even # of pins			
	★ 44 Plating Non-Standard 851-XX-0__-30-001000 Specify # of pins \rightarrow 01-50			
Fig. 3R	Single Row Socket, Right Hand Footprint Even # of pins			
	851-XX-0__-30-002000 Specify even # of pins \rightarrow 02-50			
Fig. 4	Double Row Socket, Even # of pins			
	★ 44 Plating Non-Standard 853-XX-__-30-001000 Specify even # of pins \rightarrow 004-100			
SPECIFY PLATING CODE XX=		93	99	43 \diamond 44 \diamond
Sleeve (Pin)		200 μ " Sn/Pb	200 μ " Sn/Pb	200 μ " Sn 200 μ " Sn
Contact (Clip)		30 μ " Au	200 μ " Sn/Pb	30 μ " Au 200 μ " Sn